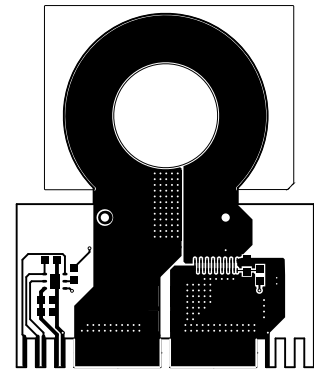
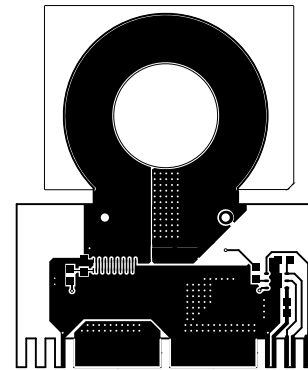


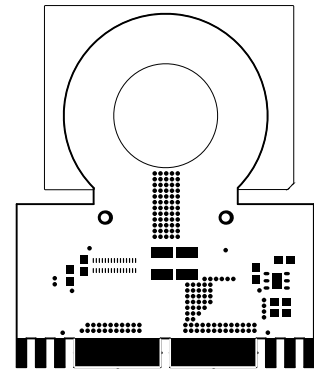
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_XFMR REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #:	
PLOT NAME = Top Solder Mask	GENERATED : 4/11/2016 1:10:14 PM	TEXAS INSTRUMENTS



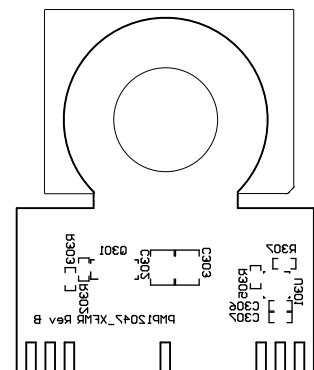
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_XFMR REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #:	
PLOT NAME = Top Layer	GENERATED : 4/11/2016 1:10:15 PM	TEXAS INSTRUMENTS



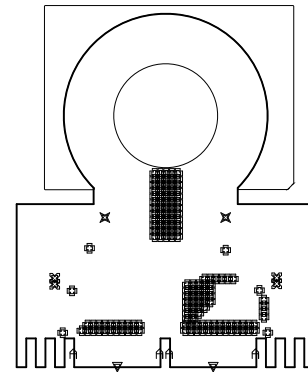
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_XFMR REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #:	
PLOT NAME = Bottom Layer	GENERATED : 4/11/2016 1:10:17 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_XFMR REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #:	
PLOT NAME = Bottom Solder Mask	GENERATED : 4/11/2016 1:10:19 PM	TEXAS INSTRUMENTS



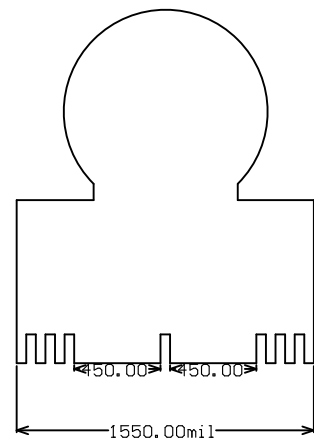
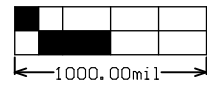
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_XFMR REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #:	
PLOT NAME = Bottom Overlay	GENERATED : 4/11/2016 1:10:21 PM	TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊗	4	7.87mil (0.200mm)	PTH	Round
⊕	152	10.00mil (0.254mm)	PTH	Round
⊗	2	43.00mil (1.092mm)	PTH	Round
⌒	4	10.00mil (0.254mm)	PTH	Slot
∇	2	10.00mil (0.254mm)	PTH	Slot
164 Total				

Slot definitions : Routed Path Length = Calculated from tool start centre position to tool end centre position.
Hole Length = Routed Path Length + Tool Size = Slot length as defined in the PCB layout

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_XFMR REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #:	
PLOT NAME = Drill Drawing	GENERATED : 4/11/2016 1:10:23 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_XFMR REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #:	
PLOT NAME = Board Dimensions	GENERATED : 4/11/2016 1:10:25 PM	TEXAS INSTRUMENTS

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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